

09/8/3459

06/02/01

Class	Subclass
ISSUE CLASSIFICATION	

## U.S. UTILITY Patent Application

O.I.P.E.	PATENT DATE
SCANNED <i>AD</i> <i>ACI</i> Q.A. <i>WAS</i>	

APPLICATION NO.	CONT/PRIOR	CLASS	SUBCLASS	ART UNIT	EXAMINER
09/873059		257	678+	2811	<i>THAL</i> <i>CHODHURY</i>

APPLICANTS

Kenneth Philpot

2827

TITLE

Enhanced performance surface mount semiconductor package devices and methods

PTO-2040  
12/99

## ISSUING CLASSIFICATION

ORIGINAL		CROSS REFERENCE(S)					
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)				
INTERNATIONAL CLASSIFICATION							

☐ Continued on Issue Slip Inside File Jacket

<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>	<b>DRAWINGS</b>			<b>CLAIMS ALLOWED</b>	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.  <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____	(Assistant Examiner) _____ (Date) _____  (Primary Examiner) _____ (Date) _____			<b>NOTICE OF ALLOWANCE MAILED</b>	
				<b>ISSUE FEE</b>	
				Amount Due	Date Paid
<input type="checkbox"/> The terminal _____ months of				<b>ISSUE BATCH NUMBER</b>	